

Surface Mount PAR® Transient Voltage Suppressors

High Temperature Stability and High Reliability Conditions



DO-218AB

FEATURES

- Junction passivation optimized design passivated anisotropic rectifier technology
- $T_J = 175$ °C capability suitable for high reliability and automotive requirement
- Low leakage current
- Low forward voltage drop
- High surge capability
- Meets ISO7637-2 surge specification
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS
COMPLIANT

PRIMARY CHARACTERISTICS

| | |
|-------------------------------|--------|
| V_{BR} | 27 V |
| P_{PPM} (10 x 1000 μ s) | 4600 W |
| P_D | 6 W |
| I_{RSM} | 90 A |
| I_{FSM} | 600 A |
| T_J max. | 175 °C |

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting, especially for automotive load dump protection application.

MECHANICAL DATA

Case: DO-218AB

Molding compound meets UL 94 V-0 flammability rating
Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Heatsink is anode

MAXIMUM RATINGS ($T_C = 25$ °C unless otherwise noted)

| PARAMETER | SYMBOL | VALUE | UNIT |
|--|----------------|---------------|------|
| Peak pulse power dissipation with 10/1000 μ s waveform | P_{PPM} | 4600 | W |
| Power dissipation on infinite heatsink at $T_C = 25$ °C (fig. 1) | P_D | 6.0 | W |
| Non-repetitive peak reverse surge current for 10 μ s/10 ms exponentially decaying waveform | I_{RSM} | 90 | A |
| Maximum working stand-off voltage | V_{WM} | 22.0 | V |
| Peak forward surge current 8.3 ms single half sine-wave | I_{FSM} | 600 | A |
| Operating junction and storage temperature range | T_J, T_{STG} | - 55 to + 175 | °C |

| ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted) | | | | | | | |
|--|-------------------------|---------------------------|----------------------|------|------|------|----------------------------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Reverse Zener voltage | $I_Z = 10 \text{ mA}$ | | V_Z | 24.0 | - | 30.0 | V |
| Zener voltage temperature coefficient | $I_Z = 10 \text{ mA}$ | | V_{ZTC} | - | - | 36 | $\text{mV}/^\circ\text{C}$ |
| Clamping voltage for 10 $\mu\text{s}/10 \text{ ms}$ exponentially decaying waveform | $I_{PP} = 65 \text{ A}$ | | V_C | - | - | 40.0 | V |
| Instantaneous forward voltage | $I_F = 6.0 \text{ A}$ | | V_F ⁽¹⁾ | - | - | 0.99 | V |
| | $I_F = 100 \text{ A}$ | | | - | 0.94 | - | |
| Reverse leakage current | Rated V_{WM} | $T_J = 25^\circ\text{C}$ | I_R | - | - | 0.5 | μA |
| | | $T_J = 175^\circ\text{C}$ | | - | - | 20.0 | |

Note

⁽¹⁾ Measured on a 300 μs square pulse width

| THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | |
|---|-----------------|-------|---------------------------|
| PARAMETER | SYMBOL | VALUE | UNIT |
| Typical thermal resistance, junction to case | $R_{\theta JC}$ | 0.95 | $^\circ\text{C}/\text{W}$ |

| ORDERING INFORMATION (Example) | | | | |
|---------------------------------------|-----------------|------------------------|---------------|---|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| SM6A27HE3/2D ⁽¹⁾ | 2.550 | 2D | 750 | 13" diameter plastic tape and reel, anode towards the sprocket hole |

Note

⁽¹⁾ AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

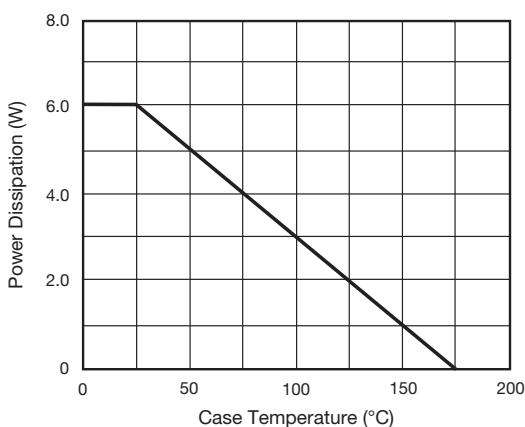


Fig. 1 - Power Derating Curve

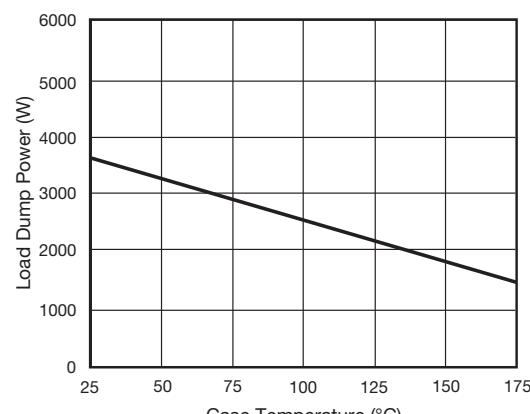


Fig. 2 - Load Dump Power Characteristics
(10 ms Exponential Waveform)

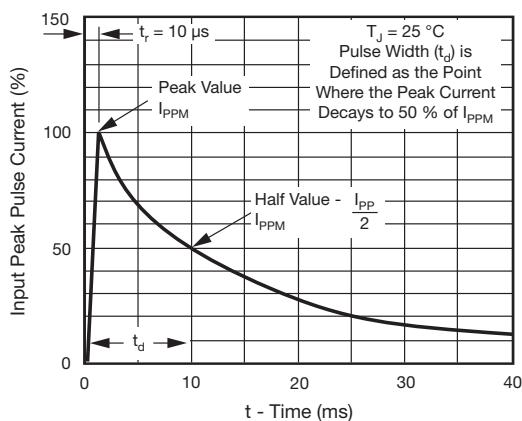


Fig. 3 - Pulse Waveform

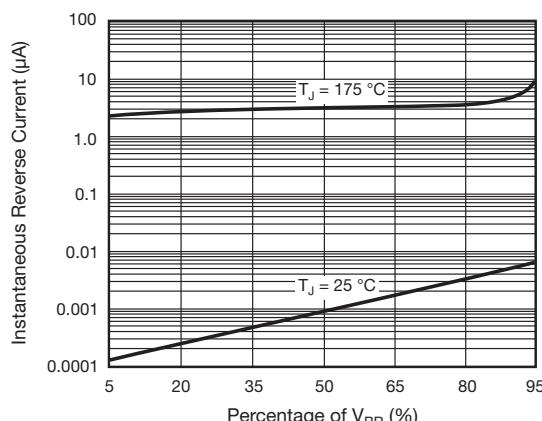


Fig. 6 - Typical Reverse Characteristics

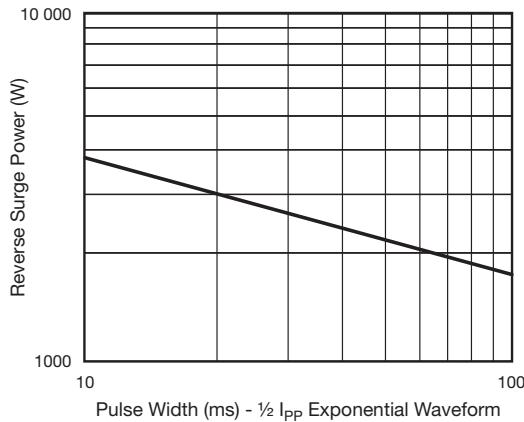


Fig. 4 - Reverse Power Capability

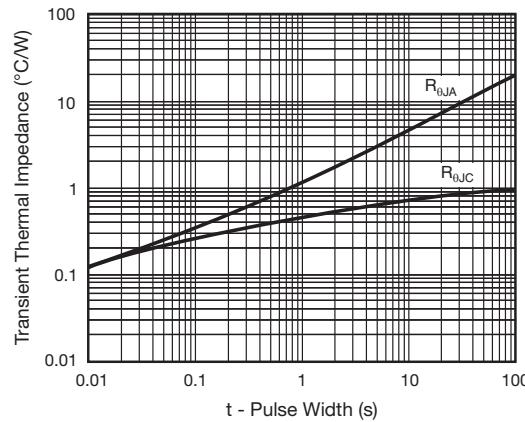


Fig. 7 - Typical Transient Thermal Impedance

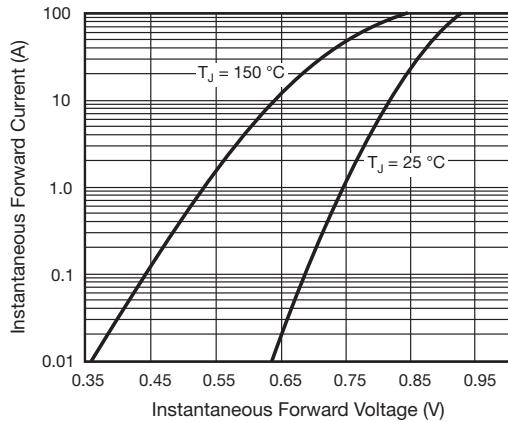
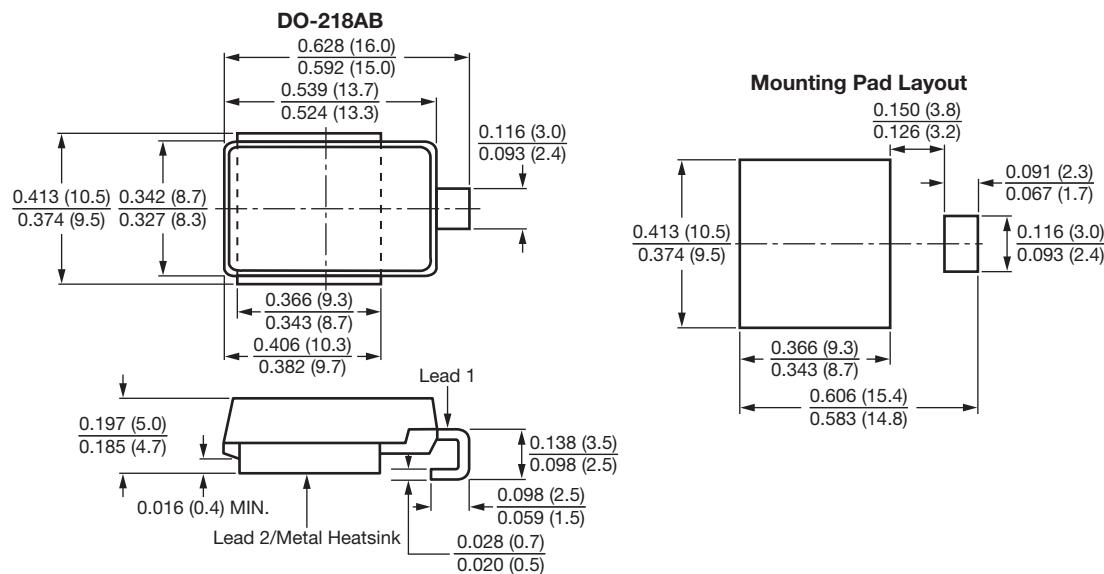


Fig. 5 - Typical Instantaneous Forward Characteristics

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)


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